

Features and Benefits

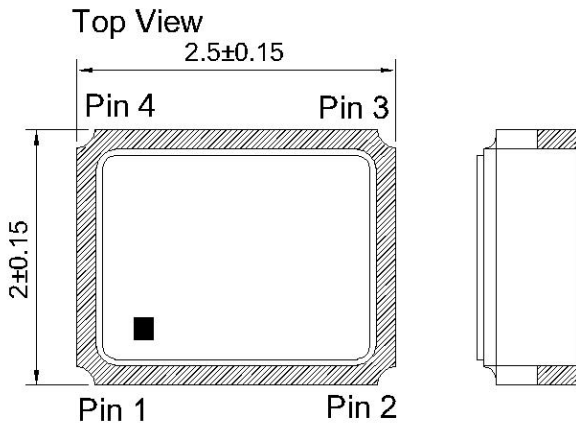
Better than +/-0.5PPM from -40°C to +85°C
 16.32MHz clipped sine wave output
 3.3V supply, 1.5mA maximum current

Typical Applications

Mobile SATCOM
 Mobile Radio
 Hand-carry Instrument
 Femto-cell

Mechanical Drawing & Pin Connections

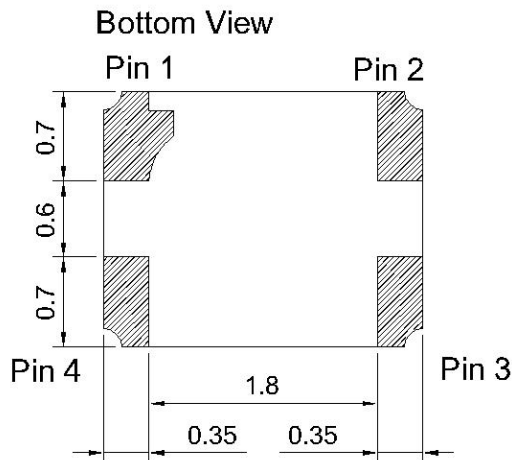
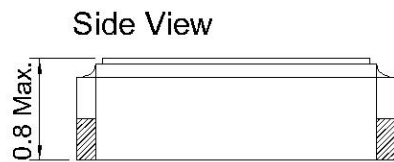
Drawing No: MD150037-1



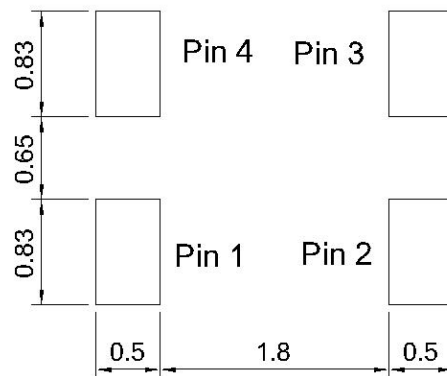
Pin Connection

Name	Function
Pin 1	AFC
Pin 2	GND
Pin 3	OUTPUT
Pin 4	VCC

Unit : mm



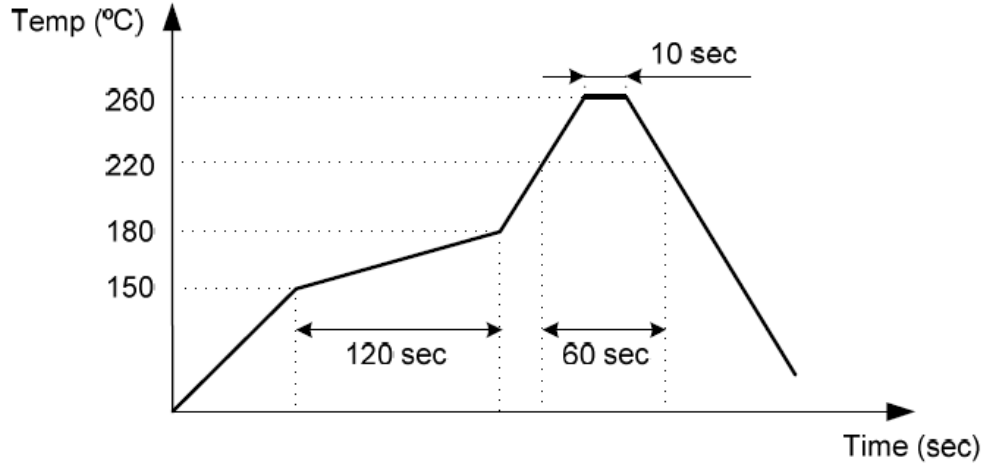
Recommended Land Pattern



Specification

Oscillator Specification	Sym	Condition	Value			Unit	Note
			Min.	Typ.	Max.		
Nominal Frequency	F _{nom}			16.320000		MHz	
Output Wave Form			Clipped Sine Wave				
Output Level			0.8			V	
Output Load		Resistance	9	10	11	Kohm	
		Capacitance	9	10	11	pF	
Duty Cycle			45	50	60	%	
Power Supply							
Supply Voltage	V _{cc}		3.135	3.3	3.465	V	
Supply Current					1.5	mA	
Frequency Control*							
Control Voltage Range	V _c		0	1.65	3.3	V	
Tuning Range		3.3V	+9		+15	ppm	Reference to VCON at 1.65V
		0V	-15		-9		
Frequency Stability							
VS. Temperature		From -40°C to +85°C			+/-0.5	ppm	
Tolerance at +25°C		At shipping			+/-1.5	ppm	
		After 2times reflow			+/-1	ppm	
VS. Supply Voltage		+/-5% change			+/-0.2	ppm	
VS. Load Change		+/-10% change			+/-0.2	ppm	
Year Aging		First year at 25°C			+/-1.0	ppm	
Slop of Frequency Drift over Temperature					+/-0.3	ppm/°C	
Phase Noise (typ.)		@10 Hz			-91	dBc/Hz	
		@100 Hz			-115		
		@1 KHz			-136		
		@10 KHz			-149		
		@100 KHz			-151		
Parameter							
Operating Temperature range	-40°C to +85°C		Criteria				
Storage Temperature range	-40°C to +85°C						
Drop Test	Height: 100cm height Direction: X,Y,Z 6 directions Test cycles: 3 cycles Fall freely on to concrete floor Mounting on test fixture(total weight=100 g)		+/-2.0 ppm				
Mechanical Shock	Acceleration: 1000g Duration: 0.5ms Test cycles: 3 times for all 3 directions		+/-2.0 ppm				
Vibration	Frequency range: 10 to 2000Hz Amplitude: 1.52mm(10 to 80Hz) Acceleration: 20g(80 to 2000Hz) Sweep speed: 20 minutes/cycle Direction: X,Y,Z 3 directions Duration: 4 hours/each direction		+/-2.0 ppm				
Gross Leak	Standard sample for automatic gross leak detector Test pressure: 2kg/cm ²		<1.5x10 ⁻⁵ Pa m ³ /sec				
Fine Leak	Helium bomging 4.5 kgf/ cm ² for 2 hours		<1.0x10 ⁻⁹ Pa m ³ /sec				
Solder Ability	Preheat temperature: 125°C+/-5°C Preheat time: 120 sec Soldering temperature: 245°C+/-5°C Duration: 5+/-1sec Method: Solder bath method		90% Coated				
High Temp. Storage	Temperature : +125°C ± 3°C Duration : 168 hours		+/- 2.0 ppm				
Low Temp. Storage	Temperature : -40°C ± 3°C Duration : 500 hours		+/- 2.0 ppm				
High Temp& Humidity	Temperature : 85°C ± 3°C Humidity: RH 85% Duration : 168 hours		+/- 2.0 ppm				
Aging	Temperature : 85°C ± 3°C Duration : 500 hours Voltage input by specification		+/- 2.0 ppm				

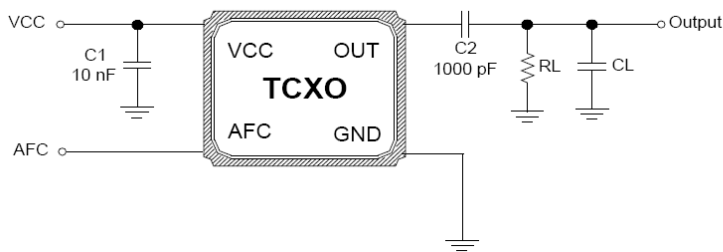
Suggested Reflow Profile



Note 1: Period while temperature exceeds the solder melting point : 220°C should be less than 200 sec

Note 2: Period while temperature stays at the top melting point : 260°C should be less than 30 sec.

Test Circuit



External Components

Name	Function
C1	AC Noise Bypass for VCC
C2	DC Block for Output
RL	Load Resistance
CL	Load Capacitance